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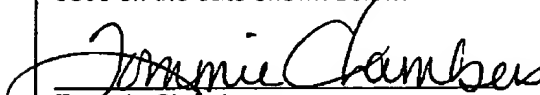
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NAME OF INVENTOR(S): Abbott	
RECEIPT DATE & SERIAL NO.: Serial No.: 09/514,762 Filing Date: 2/28/2000	
TITLE OF INVENTION: DOUBLE SIDED FLEXIBLE CIRCUIT FOR INTEGRATED CIRCUIT PACKAGES AND METHOD OF MANUFACTURE	
TI FILE NO.: TI-26904	DEPOSIT ACCT. NO.: 20-0668
FAXED: <u>3-30-04</u> DUE: <u>3-16-04</u> ATTY/SECY: WDS/vic	

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